	p 4	·				1141		x Truz 20/92	<i>538</i>	
All	ROA IN	THE	UNITED STAT	TES PATENT		AND TRAI	DEMARK OF	FICE		
In re Applicate	on of: Sar	ıg You	ung Wim et a	al.		)	Docke	t No.:	9983.3-US	S-01
Serial No. 200	1.964 362	Fi	iled: Oct.	21, 1992		)	Group	Art U	nit: 1107	高
For: METHOD FOR FILLING CONTACT HOLES WITH METAL BY ) Examiner: Unknown 1 TWO-STEP DEPOSITION										
The Commissioner of Patents and Trademarks Washington, D.C. 20231 Sir:										
Sir:										Æ
We are transmitting herewith the attached:  [ ] An assignment of the invention to corporation.										
[] A certifi	ed copy of	, a a	appli	cation. Se	er	ial No.		f	iled c	orporation.
[] A certified copy of a application, Serial No, filed, 19, the right of priority of which is claimed under 35 U.S.C. 119. [] Small entity status of this application under 37 C.F.R. 1.9 and 1.27 has been established by verified statement previously submitted.										
[ ] A verified statement to establish small entity status under 37 C.F.R. 1.9 and 1.27 is enclosed.										
[X] Other: <u>IN</u>	FORMATION D	ISCLO	SURE STATEM	ENT, FORM	1	449, CI	TED REFEI	RENCES		
AmendmentNo Additional fee is requiredThe fee has been calculated as shown:  CLAIMS AS AMENDED										
	(1)	#	(2)	(3)	16		ENTITY	<u> </u>	07	THER
MO MAY	CLAIMS REMAINING AFTER AMENDMENT	# # #	HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA		RATE	ADD'L FEE	<u>or</u>	RATE	ADD'L FEE
TOTAL CLAIMS		-	=			x 11 =	\$	or	x 22 =	\$
INDEPENDENT CLAIMS		_	. =			x 37 =	s	or	x 74 =	\$
( ) FIRST	PRESENTATION MULTIPLE DE		ENT CLAIM			+115 =	Ś	or	+ 230 =	\$
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Please charge any additional fees or credit overpayment to Deposit Account No. 13-2725. A duplicate copy of this sheet is enclosed.										
CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this Transmittal Letter and the paper, as described hereinabove, are being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on this										

(GENERAL)